JEPPE HINRICHS

Copenhagen, Denmark

Employment History

2024-now	Firmware Engineer, Research & Development, Sensata Technologies
2021 - 2023	Graduate Researcher, Brain/Biomedical Microsystems Laboratory
2015 - 2017	Electrical Engineer, Development & Engineering, Welltec
2014 - 2015	Intern, Development & Engineering, Welltec

Education

2021 - 2023	Master of Science in Electrical Engineering, Korea Advanced Institute of Science & Technology
2021 - 2023	Master of Science in Electrical Engineering, Technical University of Denmark
2020	Research Student (Exchange), Tokyo Institute of Technology, Japan
2018 - 2020	Bachelor of Electrical Engineering, Technical University of Denmark
2013 - 2015	Associate in IT-Technology, Aarhus Business Academy

₹ Selected Projects

2024 Temperature sensor characterization and optimization | C++

- Conducted investigation of computational overhead and accuracy of Steinhart-Hart model
- Implemented optimized temperature calculation algorithm with binary search and linear interpolation
- Performance metrics on target increased by > 60% using improved algorithm compared to baseline

2023 Master Thesis | LTspice, Altium Designer, MATLAB, Xilinx Vivado, Python

- Title: Portable ultrasound system for blood velocity estimation
- Analysed research in devices for estimating the velocity of blood
- Designed system architecture of portable pulsed-wave Doppler ultrasound imaging device
- Implemented Zynq 7000 FPGA bitstream for ultrasound pulser control system
- Implemented MCU/FPGA interconnects and registers
- Synthesised ARM Cortex[©]-A9 based DSP with Fourier analysis

2020 Bachelor Thesis | LTspice, Altium Designer, MATLAB, Simulink

- Title: Influence of the output filter parasitic elements on a switch-mode audio amplifier
- Led a study into hitherto unexplored control theory of parasitic elements in electronic components
- Simulated and synthesized AIM class-D amplifier design
- Devised proposal of compensation strategy to improve control loops affected by parasitic elements

2017 Well Depth Acquisition | C++, Fusion 360, OrCAD

- Project lead on solution to enable universal telemetry capability during intervention and logging
- Managed a team of engineers in implementing an integration with existing flagship products
- Implemented mission-critical master and multi-slave half-duplex communications bus over RS485
- Conducted field testing in Germany, Netherlands, Malaysia, and the United States

★ Skills

Languages Danish, English, German, Japanese, Korean

Coding </br>
C/C++, Python, Bash, LabVIEW, Assembly, Make

CAE/CAD

Altium Designer, KiCAD, OrCAD, LTspice, Qspice, Simulink, Fusion 360

Technologies > Linux, Git, RTOS, Xilinx Vivado, MATLAB, NI-DAQ

Misc. Academic research, teaching, training, microcontrollers, computer hardware, exercise, music

Q Miscellaneous Experience

2023 Scholarship Award, from Siemens Foundation for research project funding at KAIST in South Korea

2020 Scholarship Award, from Scandinavia-Sasakawa Foundation for research project at Tokyo Institute of Technology in Japan